

March 1997

Features

- For Applications in Aerospace, Military, and Critical Industrial Equipment
- Compatible with CDP1800-Series Microprocessors at Maximum Speed
- Interfaces with CDP1800-Series Microprocessors without Additional Components
- Fast Access Time
- At $V_{DD} = 5V, +25^{\circ}C$ 275ns
- Single Voltage Supply
- Common Data Inputs and Outputs
- Multiple Chip Select Inputs to Simplify Memory System Expansion
- High Noise Immunity 30% of V_{DD}
- Memory Retention for Standby Battery Voltage Down

to 2V at $25^{\circ}C$

- Latch-Up-Free Transient Radiation Tolerance

Ordering Information

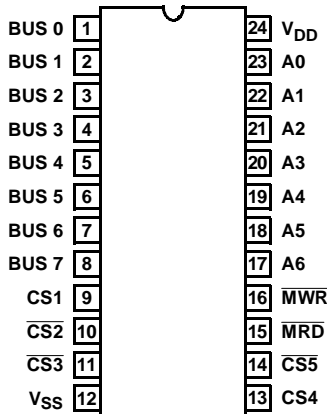
PACKAGE	TEMP. RANGE	PART NUMBER (5V)	PKG. NO.
SBDIP	$-55^{\circ}C$ to $+125^{\circ}C$	CDP1823CD3	D24.6

Description

The CDP1823C/3 is a 128 word x 8-bit CMOS/SOS static random access memory. It is compatible with the CDP1802, CDP1804, CDP1805, and CDP1806 microprocessors, and will interface directly without additional components. The CDP1823C has a recommended operating voltage range of 4V to 6.5V.

Pinout

**CDP1823C/3
(SBDIP)
TOP VIEW**



CDP1823C/3

OPERATIONAL MODES

FUNCTION	$\overline{\text{MRD}}$	$\overline{\text{MWR}}$	CS1	$\overline{\text{CS2}}$	$\overline{\text{CS3}}$	CS4	$\overline{\text{CS5}}$	BUS TERMINAL STATE
Read	0	X	1	0	0	1	0	Storage State of Addressed Word
Write	1	0	1	0	0	1	0	Input High Impedance
Standby	1	1	1	0	0	1	0	High Impedance
Not Selected	X	X	0	X	X	X	X	High Impedance
	X	X	X	1	X	X	X	
	X	X	X	X	1	X	X	
	X	X	X	X	X	0	X	
	X	X	X	X	X	X	1	

NOTE:

1. Logic 1 = High, Logic 0 = Low, X = Don't Care.

CDP1823C/3

Absolute Maximum Ratings

DC Supply Voltage Range, (V_{DD})
 (All Voltages Referenced to V_{SS} Terminal)
 CDP1823C/3 -0.5V to +7V
 Input Voltage Range, All Inputs -0.5V to $V_{DD} + 0.5V$
 DC Input Current, Any One Input $\pm 10mA$

Thermal Information

Thermal Resistance (Typical) θ_{JA} ($^{\circ}C/W$) θ_{JC} ($^{\circ}C/W$)
 SBDIP Package 60 17
 Maximum Operating Temperature Range (T_A) $-55^{\circ}C$ to $+125^{\circ}C$
 Maximum Storage Temperature Range (T_{STG}) $-65^{\circ}C$ to $+150^{\circ}C$
 Maximum Lead Temperature (During Soldering) $+265^{\circ}C$
 Maximum Junction Temperature $+150^{\circ}C$

Recommended Operating Conditions

At T_A = Full Package Temperature Range. For maximum reliability, operating conditions should be selected so that operation is always within the following ranges:

PARAMETER	LIMITS		UNITS
	MIN	MAX	
Supply Voltage Range	4	6.5	V
Recommended Input Voltage Range	V_{SS}	V_{DD}	V

Static Electrical Specifications $V_{DD} = 5V \pm 5\%$

PARAMETER		CONDITIONS			LIMITS				UNITS
		V _O (V)	V _{IN} (V)	V _{DD} (V)	-55°C, +25°C		+125°C		
					MIN	MAX	MIN	MAX	
Quiescent Device Current (Note 1)	I _{DD}	-	0, 5	5	-	270	-	1000	μA
Output Low (Sink) Current (Note 1)	I _{OL}	0.4	0, 5	5	2.7	-	1.5	-	mA
Output High (Source) Current (Note 1)	I _{OH}	4.6	0, 5	5	-	-1.3	-	-0.7	mA
Output Voltage Low-Level	V _{OL}	-	0, 5	5	-	0.1	-	0.1	V
Output Voltage High-Level	V _{OH}	-	0, 5	5	V _{DD} - 0.1	-	V _{DD} - 0.1	-	V
Input Low Voltage	V _{IL}	0.5, 4.5	-	5	-	0.3 V _{DD}	-	0.3 V _{DD}	V
Input High Voltage	V _{IH}	0.5, 4.5	-	5	0.7 V _{DD}	-	0.7 V _{DD}	-	V
Input Leakage Current (Note 1)	I _{IN}	-	0, 5	5	-	±2.6	-	±10	μA
Operating Current (Note 1)	I _{DD1}	-	0, 5	5	-	5	-	10	mA
Three-State Output Leakage Current	I _{OUT}	0, 5	0, 5	5	-	±2.6	-	±10	μA
Input Capacitance	C _{IN}	-	-	-	-	7.5	-	7.5	pF
Output Capacitance	C _{OUT}	-	-	-	-	15	-	15	pF

NOTE:

- Limits designate 100% testing, all other limits are designer's parameters under given test conditions and do not represent 100% testing.

Read Cycle Dynamic Electrical Specifications $t_R, t_F = 10ns, C_L = 50pF$

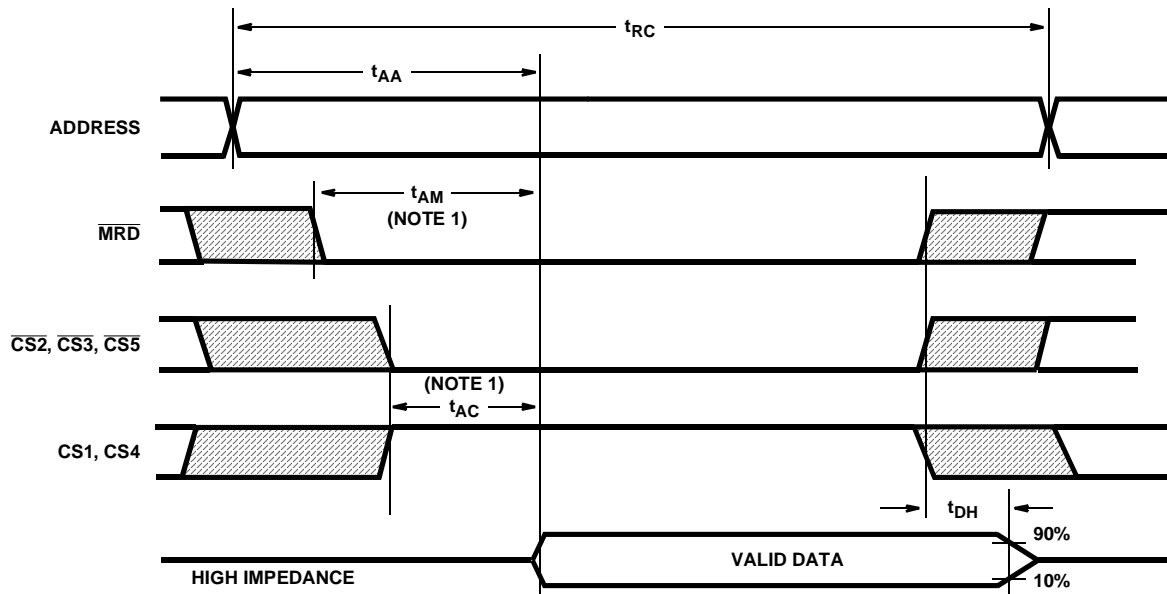
PARAMETER	SYMBOL	V _{DD} (V)	LIMITS				UNITS
			+25°C, -55°C		+125°C		
			MIN	MAX	MIN	MAX	
Read Cycle	t _{RC}	5	360	-	505	-	ns
Access Time from Address Change (Note 1)	t _{AA}	5	-	360	-	505	ns
Access Time from Chip Select	t _{AC}	5	-	360	-	505	ns

Read Cycle Dynamic Electrical Specifications $t_R, t_F = 10\text{ns}$, $C_L = 50\text{pF}$ (Continued)

PARAMETER	SYMBOL	V _{DD} (V)	LIMITS				UNITS
			+25°C, -55°C		+125°C		
			MIN	MAX	MIN	MAX	
Access Time from $\overline{\text{MRD}}$ (Note 1)	t _{AM}	5	-	310	-	435	ns
Data Hold Time After Read	t _{DH}	5	50	-	70	-	ns

NOTE:

1. Limits designate 100% testing. All other limits are designer's parameters under given test conditions and do not represent 100% testing.



NOTES:

1. Minimum timing for valid data output. Longer times will initiate an earlier but invalid output.
2. $\overline{\text{MWR}}$ is high during read operation. Timing measurement reference is $0.5V_{DD}$.

FIGURE 1. READ CYCLE TIMING DIAGRAM

Write Cycle Dynamic Electrical Specifications $t_R, t_F = 10\text{ns}$, $C_L = 50\text{pF}$

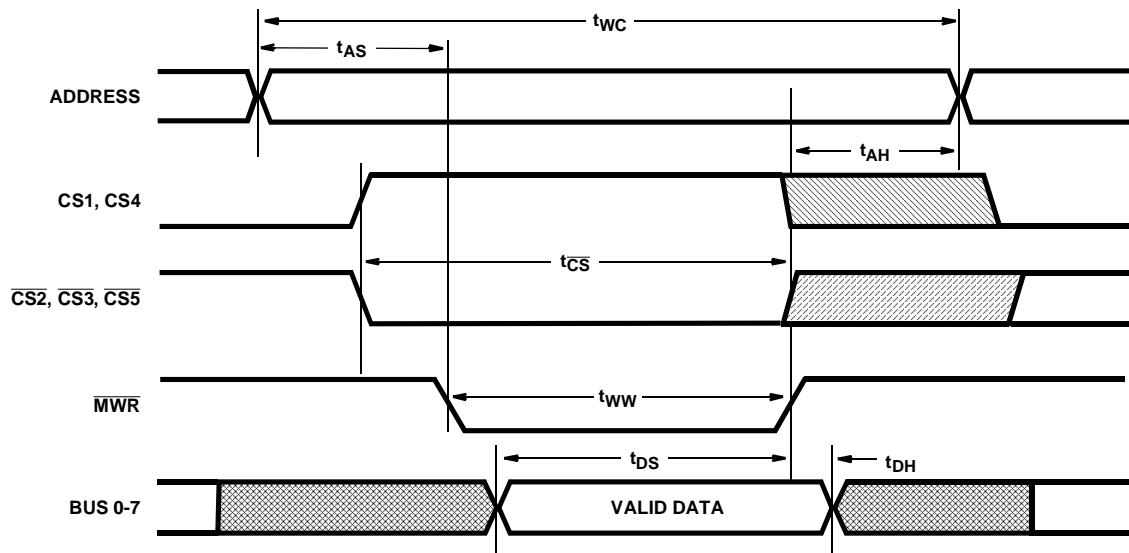
PARAMETER	SYMBOL	V _{DD} (V)	LIMITS				UNITS
			+25°C, -55°C		+125°C		
			(NOTE 2) MIN	MAX	(NOTE 2) MIN	MAX	
Write Cycle	t _{WC}	5	280	-	400	-	ns
Address Setup Time (Note 1)	t _{AS}	5	70	-	100	-	ns
Address Hold Time	t _{AH}	5	70	-	100	-	ns
Write Pulse Width (Note 1)	t _{WW}	5	140	-	200	-	ns
Data to $\overline{\text{MWR}}$ Setup Time (Note 1)	t _{DS}	5	70	-	100	-	ns

Write Cycle Dynamic Electrical Specifications $t_R, t_F = 10\text{ns}$, $C_L = 50\text{pF}$ (Continued)

PARAMETER	SYMBOL	V _{DD} (V)	LIMITS				UNITS
			+25°C, -55°C		+125°C		
			(NOTE 2) MIN	MAX	(NOTE 2) MIN	MAX	
Data Hold Time from \overline{MWR} (Note 1)	t _{DH}	5	50	-	70	-	ns
Chip Select Setup	t _{CS}	5	210	-	300	-	ns

NOTES:

- Limits designate 100% testing. All other limits are designer's parameters under given test conditions and do not represent 100% testing.
- Minimum timing to allow the indicated function to occur.



NOTE:

- \overline{MRD} must be high during write operation.

FIGURE 2. WRITE CYCLE TIMING WAVEFORMS

Data Retention Specifications

PARAMETER	SYMBOL	TEST CONDITIONS		LIMITS				UNITS
		V _{DR} (V)	V _{DD} (V)	+25°C, -55°C		+125°C		
				MIN	MAX	MIN	MAX	
Minimum Data Retention Voltage (Note 1)	V _{DR}	-	-	-	2	-	2.5	V
Data Retention Quiescent Current	I _{DD}	2	-	-	100	-	400	μA
Chip Deselect to Data Retention Time	t _{CDR}	-	5	450	-	650	-	ns
Recovery to Normal Operation Time	t _{RC}	-	5	450	-	650	-	ns

NOTE:

- Limits designate 100% testing. All other limits are designer's parameters under given test conditions and do not represent 100% testing.

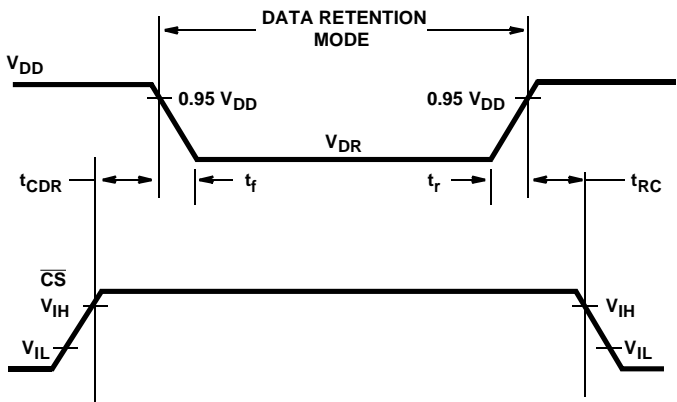
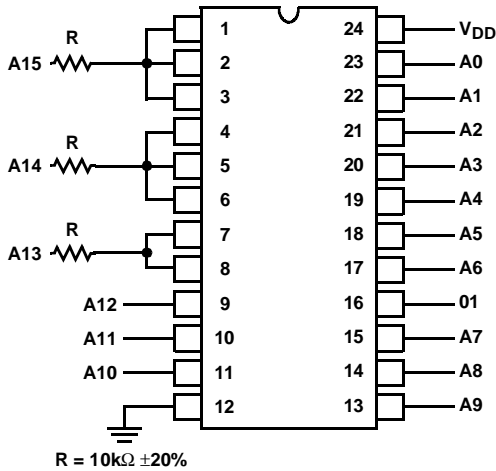
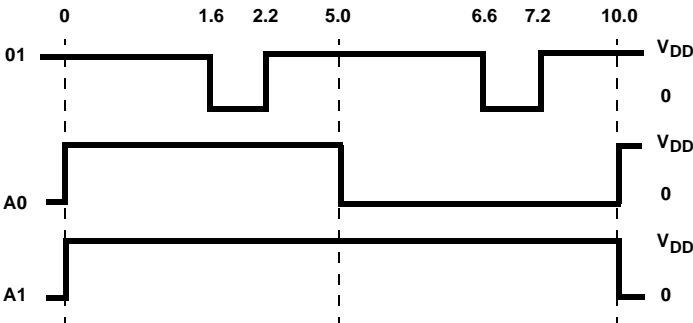


FIGURE 3. LOW V_{DD} DATA RETENTION WAVEFORMS



PACKAGE	TEMPERATURE	DURATION	V_{DD}
D	125°C	160 Hrs	7V



NOTE:

1. A1 - A11 are division by 2 based on A0.

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